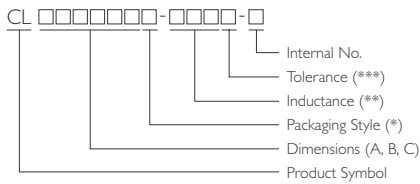


Multilayer Chip Inductors

CL Series



PRODUCT IDENTIFICATION



- * B: Bulk ; T: Tape and Reel
- ** Example : 47N = 47nH
R10 = 0.1μH IR0 = 1.0μH
- *** K = ±10% M = ±20%

APPLICATIONS

Personal computers, HDDs, or other various electronic appliances.

Any general circuit of portable equipment in which compact size and high mounting densities are required.

OUTLINE

Yageo's SMD multi-layered chip inductors provide a cost effective solution for densely packed PC board designs. Using Ferrite or CL / CLH series ceramic materials are available in broad band and high frequency circuits. The ferrite structure is suited for lower frequency applications and the ceramic one, CLH series, is designed to meet the needs of higher frequency circuits.

FEATURES

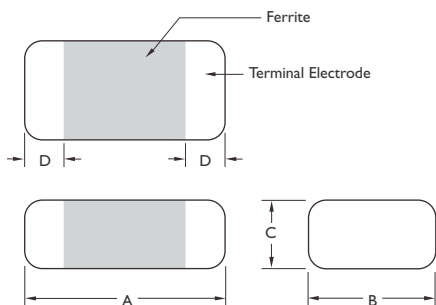
High mounting density of compact circuit due to crosstalk elimination that results from a closed magnetic flux in a ferrite material.

Suitable for Flow and Re-flow Soldering

Available in 5 Sizes

SHAPES AND DIMENSIONS

Dimensions : mm



TYPE	A	B	C	D
CL160808	1.6 ± 0.20	0.80 ± 0.15	0.80 ± 0.15	0.3 ± 0.2
CL201209	2.0 ± 0.20	1.25 ± 0.20	0.90 ± 0.20	0.5 ± 0.3
CL201212	2.0 ± 0.20	1.25 ± 0.20	1.25 ± 0.20	0.5 ± 0.3
CL321611	3.2 ± 0.20	1.60 ± 0.20	1.10 ± 0.20	0.5 ± 0.3



ELECTRICAL CHARACTERISTICS CLI60808 (0603) SERIES

PART NO.	INDUCTANCE (μ H)	TOLERANCE (\pm %)	Q Min.	TEST FREQUENCY (MHz)	SRF (MHz) Min.	DC RESISTANCE (Ω) Max.	IDC (mA) Max.
CLI60808T-10NM-S	0.010	20%	15	50	300	0.20	50
CLI60808T-33NM-S	0.033	20%	15	50	270	0.20	50
CLI60808T-47NM-S	0.047	20%	15	50	260	0.30	50
CLI60808T-68NM-S	0.068	20%	15	50	250	0.30	50
CLI60808T-82NM-S	0.082	20%	15	50	245	0.30	50
CLI60808T-R10□-S	0.10	20 or 10%	25	25	240	0.50	50
CLI60808T-R12□-S	0.12	20 or 10%	25	25	205	0.50	50
CLI60808T-R15□-S	0.15	20 or 10%	25	25	180	0.60	50
CLI60808T-R18□-S	0.18	20 or 10%	25	25	165	0.60	50
CLI60808T-R22□-S	0.22	20 or 10%	25	25	150	0.80	50
CLI60808T-R27□-S	0.27	20 or 10%	25	25	136	0.80	50
CLI60808T-R33□-S	0.33	20 or 10%	25	25	125	0.85	35
CLI60808T-R39□-S	0.39	20 or 10%	25	25	110	1.00	35
CLI60808T-R47□-S	0.47	20 or 10%	25	25	105	1.35	35
CLI60808T-R56□-S	0.56	20 or 10%	25	25	95	1.50	35
CLI60808T-R68□-S	0.68	20 or 10%	25	25	85	1.70	35
CLI60808T-R82□-S	0.82	20 or 10%	25	25	75	2.10	35
CLI60808T-1R0□-S	1.0	20 or 10%	35	10	65	0.60	25
CLI60808T-1R2□-S	1.2	20 or 10%	35	10	60	0.80	25
CLI60808T-1R5□-S	1.5	20 or 10%	35	10	55	0.80	25
CLI60808T-1R8□-S	1.8	20 or 10%	35	10	50	0.95	25
CLI60808T-2R2□-S	2.2	20 or 10%	35	10	45	1.10	15
CLI60808T-2R7□-S	2.7	20 or 10%	35	10	40	1.30	15
CLI60808T-3R3□-S	3.3	20 or 10%	35	10	38	1.50	15
CLI60808T-3R9□-S	3.9	20 or 10%	35	10	36	1.70	15
CLI60808T-4R7□-S	4.7	20 or 10%	35	10	33	2.10	15
CLI60808T-5R6□-S	5.6	20 or 10%	35	4	22	1.50	5
CLI60808T-6R8□-S	6.8	20 or 10%	35	4	20	1.70	5
CLI60808T-8R2□-S	8.2	20 or 10%	30	4	18	2.10	5
CLI60808T-100□-S	10	20 or 10%	30	2	17	2.55	5



ELECTRICAL CHARACTERISTICS CL201209, CL201212 (0805) SERIES

PART NO.	INDUCTANCE (μ H)	TOLERANCE (\pm %)	Q Min.	TEST FREQUENCY (MHz)	SRF (MHz) Min.	DC RESISTANCE (Ω) Max.	IDC (mA) Max.
CL201209T-47NM-S	0.047	20%	20	50	320	0.20	300
CL201209T-68NM-S	0.068	20%	20	50	280	0.20	300
CL201209T-82NM-S	0.082	20%	20	50	255	0.20	300
CL201209T-R10□-S	0.10	20 or 10%	25	25	235	0.30	250
CL201209T-R12□-S	0.12	20 or 10%	25	25	220	0.30	250
CL201209T-R15□-S	0.15	20 or 10%	25	25	200	0.40	250
CL201209T-R18□-S	0.18	20 or 10%	25	25	185	0.40	250
CL201209T-R22□-S	0.22	20 or 10%	25	25	170	0.50	250
CL201209T-R27□-S	0.27	20 or 10%	25	25	150	0.50	250
CL201209T-R33□-S	0.33	20 or 10%	25	25	145	0.55	250
CL201209T-R39□-S	0.39	20 or 10%	25	25	135	0.65	250
CL201209T-R47□-S	0.47	20 or 10%	25	25	125	0.65	250
CL201209T-R56□-S	0.56	20 or 10%	25	25	115	0.75	150
CL201209T-R68□-S	0.68	20 or 10%	25	25	105	0.80	150
CL201209T-R82□-S	0.82	20 or 10%	25	25	100	1.00	150
CL201209T-1R0□-S	1.0	20 or 10%	45	10	75	0.40	50
CL201209T-1R2□-S	1.2	20 or 10%	45	10	65	0.50	50
CL201209T-1R5□-S	1.5	20 or 10%	45	10	60	0.50	50
CL201209T-1R8□-S	1.8	20 or 10%	45	10	55	0.60	50
CL201209T-2R2□-S	2.2	20 or 10%	45	10	50	0.65	30
CL201212T-2R7□-S	2.7	20 or 10%	45	10	45	0.75	30
CL201212T-3R3□-S	3.3	20 or 10%	45	10	41	0.80	30
CL201212T-3R9□-S	3.9	20 or 10%	45	10	38	0.90	30
CL201212T-4R7□-S	4.7	20 or 10%	45	10	35	1.00	30
CL201212T-5R6□-S	5.6	20 or 10%	45	4	32	0.90	15
CL201212T-6R8□-S	6.8	20 or 10%	45	4	29	1.00	15
CL201212T-8R2□-S	8.2	20 or 10%	45	4	26	1.10	15
CL201212T-100□-S	10	20 or 10%	45	2	24	1.10	15
CL201212T-120□-S	12	20 or 10%	45	2	22	1.20	15
CL201212T-150□-S	15	20 or 10%	30	1	19	0.80	5
CL201212T-180□-S	18	20 or 10%	30	1	18	0.90	5
CL201212T-220□-S	22	20 or 10%	30	1	16	1.10	5



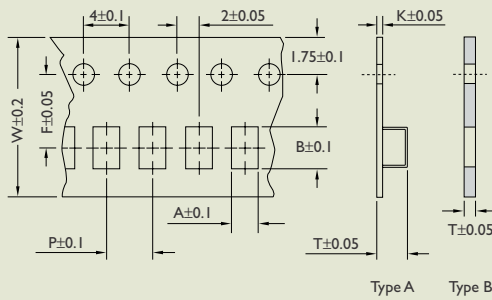
ELECTRICAL CHARACTERISTICS CL321611 (1206) SERIES

PART NO.	INDUCTANCE (μ H)	TOLERANCE ($\pm\%$)	Q Min.	TEST FREQUENCY (MHz)	SRF (MHz) Min.	DC RESISTANCE (Ω) Max.	IDC (mA) Max.
CL321611T-47NM-S	0.047	20%	20	50	320	0.15	300
CL321611T-68NM-S	0.068	20%	20	50	280	0.25	300
CL321611T-82NM-S	0.082	20%	20	50	250	0.25	300
CL321611T-R10□-S	0.10	20 or 10%	25	25	235	0.25	250
CL321611T-R12□-S	0.12	20 or 10%	25	25	220	0.30	250
CL321611T-R15□-S	0.15	20 or 10%	25	25	200	0.30	250
CL321611T-R18□-S	0.18	20 or 10%	25	25	185	0.40	250
CL321611T-R22□-S	0.22	20 or 10%	25	25	170	0.40	250
CL321611T-R27□-S	0.27	20 or 10%	25	25	150	0.50	250
CL321611T-R33□-S	0.33	20 or 10%	25	25	145	0.60	250
CL321611T-R39□-S	0.39	20 or 10%	25	25	135	0.50	200
CL321611T-R47□-S	0.47	20 or 10%	25	25	125	0.60	200
CL321611T-R56□-S	0.56	20 or 10%	25	25	115	0.70	150
CL321611T-R68□-S	0.68	20 or 10%	25	25	105	0.80	150
CL321611T-R82□-S	0.82	20 or 10%	25	25	100	0.90	150
CL321611T-1R0□-S	1.0	20 or 10%	45	10	75	0.40	100
CL321611T-1R2□-S	1.2	20 or 10%	45	10	65	0.50	100
CL321611T-1R5□-S	1.5	20 or 10%	45	10	60	0.50	80
CL321611T-1R8□-S	1.8	20 or 10%	45	10	55	0.50	70
CL321611T-2R2□-S	2.2	20 or 10%	45	10	50	0.60	60
CL321611T-2R7□-S	2.7	20 or 10%	45	10	45	0.60	60
CL321611T-3R3□-S	3.3	20 or 10%	45	10	41	0.70	60
CL321611T-3R9□-S	3.9	20 or 10%	45	10	38	0.80	50
CL321611T-4R7□-S	4.7	20 or 10%	45	10	35	0.90	50
CL321611T-5R6□-S	5.6	20 or 10%	45	4	32	0.70	25
CL321611T-6R8□-S	6.8	20 or 10%	45	4	29	0.80	25
CL321611T-8R2□-S	8.2	20 or 10%	45	4	26	0.90	25
CL321611T-100□-S	10	20 or 10%	45	2	24	1.00	25
CL321611T-120□-S	12	20 or 10%	45	2	22	1.00	15
CL321611T-150□-S	15	20 or 10%	35	1	19	0.70	5
CL321611T-180□-S	18	20 or 10%	35	1	18	0.75	5
CL321611T-220□-S	22	20 or 10%	35	1	16	0.90	5
CL321611T-270□-S	27	20 or 10%	35	1	14	0.90	5
CL321611T-330□-S	33	20 or 10%	35	1	13	1.05	5



TAPE DIMENSIONS

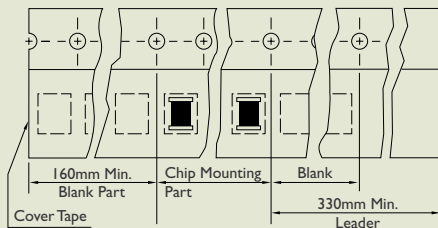
Dimensions : mm



TYPE	A	B	T	W	P	F	K	TAPE TYPE
CL160808	1.05	1.9	0.95	8.0	4.0	3.5	–	B
CL201209	1.54	2.30	1.05	8.0	4.0	3.5	0.2	A
CL201212	1.40	2.25	1.40	8.0	4.0	3.5	0.2	A
CL321611	1.88	3.50	1.27	8.0	4.0	3.5	0.2	A

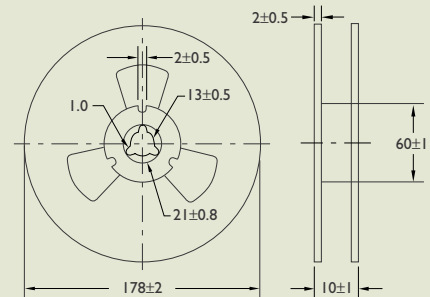
TAPE MATERIAL

Carrier Tape : Polystyrene (for 201209, 201212, 321611 Series), Paper (for 160808)
 Cover Tape : Polyethyene



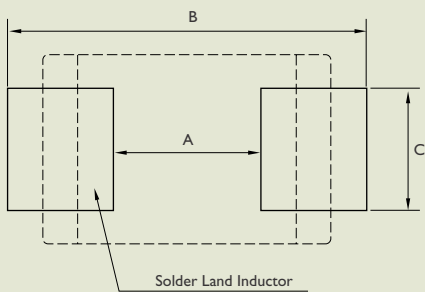
REEL DIMENSIONS

Dimensions : mm



RECOMMENDED PATTERN

Dimensions : mm



TYPE	A	B	C
CL160808	0.8	2.4 ~ 3.4	0.6
CL201209	1.2	3.0 ~ 4.0	1.0
CL201212	1.2	3.0 ~ 4.0	1.0
CL321611	2.0	4.2 ~ 5.2	1.2

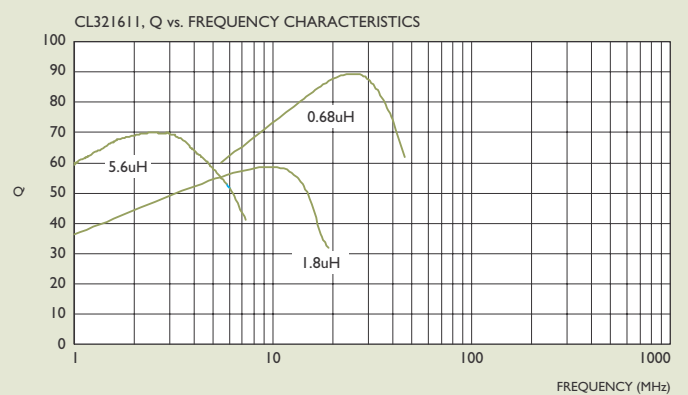
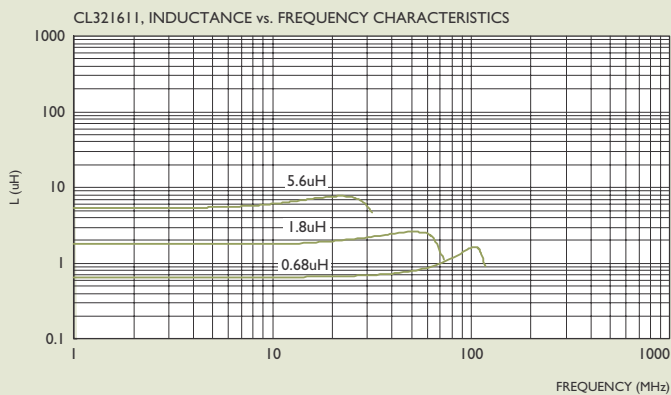
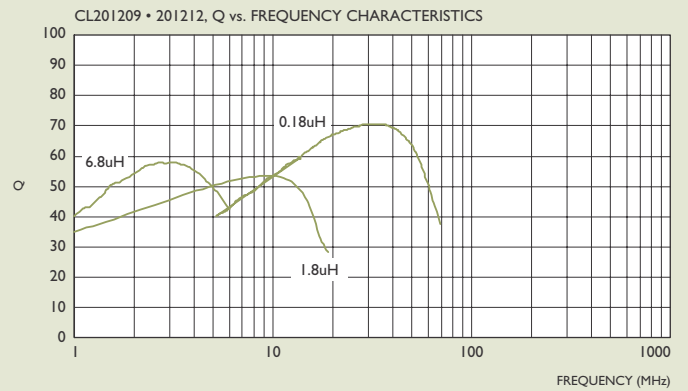
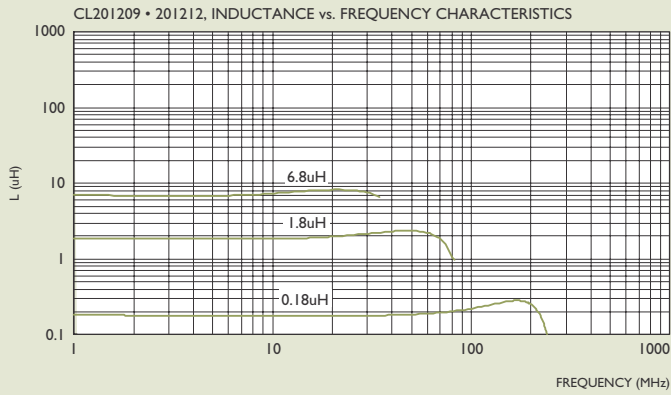
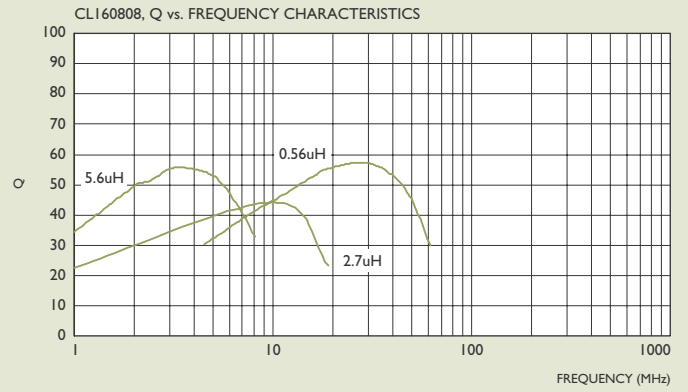
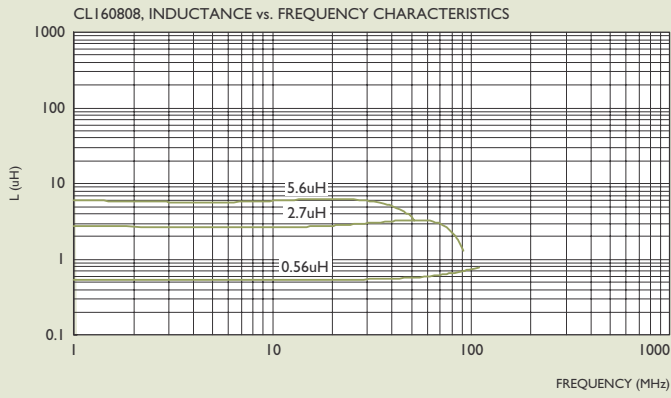
PACKAGING QUANTITY

TYPE	BULK	QUANTITY/REEL
CL160808	√	4000
CL201209	√	4000
CL201212	√	3000
CL321611	√	3000



TYPICAL ELECTRICAL CHARACTERISTICS

Test Instruments : HP4291A Impedance / Material Analyzer

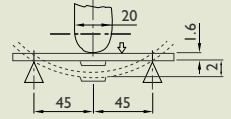




CL SERIES RELIABILITY TEST

I-1 MECHANICAL PERFORMANCE

NO.	ITEM	SPECIFICATION	TEST CONDITIONS
I-1-1	Flexure Strength	Appearance : No Damage L Change : within $\pm 10\%$ Q Change : within $\pm 30\%$	Test device shall be soldered on the substrate. Substrate Dimension : 100 x 40 x 1.6mm Deflection : 2.0mm Keeping Time : 30Sec. * For 100505, substrate dimension is 100 x 40 x 0.8mm.
I-1-2	Vibration		Test device shall be soldered on the substrate. Oscillation Frequency : 10 to 55 to 10Hz for 1Min. Amplitude : 1.5mm Time : 2Hrs. for each Axis (X,Y & Z), Total 6Hrs.
I-1-3	Resistance to Soldering Heat	Appearance : No Damage	Pre-heating : 150°C, 1Min. Solder Composition : Sn/Pb = 63/37 Solder Temperature : 260 \pm 5°C Immersion Time : 10 \pm 1Sec.
I-1-4	Solderability	The electrodes shall be at least 90% covered with new solder coating.	Pre-heating : 150°C, 1Min. Solder Composition : Sn/Pb = 63/37 Solder Temperature : 230 \pm 5°C Immersion Time : 4 \pm 1Sec.



I-2 ENVIRONMENTAL PERFORMANCE

NO.	ITEM	SPECIFICATION	TEST CONDITIONS															
I-2-1	Temperature Cycle	Appearance : No Damage L Change : within $\pm 10\%$ Q Change : within $\pm 30\%$	One Cycle <table border="1"> <thead> <tr> <th>Step</th> <th>Temperature (°C)</th> <th>Time (Min.)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-25 \pm 3</td> <td>30</td> </tr> <tr> <td>2</td> <td>25 \pm 2</td> <td>3</td> </tr> <tr> <td>3</td> <td>85 \pm 3</td> <td>30</td> </tr> <tr> <td>4</td> <td>25 \pm 2</td> <td>3</td> </tr> </tbody> </table> Total : 100 Cycles Measured after Exposure in the Room Condition for 24Hrs.	Step	Temperature (°C)	Time (Min.)	1	-25 \pm 3	30	2	25 \pm 2	3	3	85 \pm 3	30	4	25 \pm 2	3
Step	Temperature (°C)	Time (Min.)																
1	-25 \pm 3	30																
2	25 \pm 2	3																
3	85 \pm 3	30																
4	25 \pm 2	3																
I-2-2	Humidity Resistance		Temperature : 40 \pm 2°C Relative Humidity : 90 ~ 95% Time : 1000Hrs. Measured after Exposure in the Room Condition for 24Hrs.															
I-2-3	High Temperature Resistance		Temperature : 85 \pm 3°C Relative Humidity : 20% Applied Current : Rated Current Time : 1000Hrs. Measured after Exposure in the Room Condition for 24Hrs.															
I-2-4	Low Temperature Resistance		Temperature : -25 \pm 3°C Relative Humidity : 0% Time : 1000Hrs. Measured after Exposure in the Room Condition for 24Hrs.															